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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Discontinued at Digi-Key
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	CANbus, EBI/EMI, I²C, SCI, SPI, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	103
Program Memory Size	384KB (384K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	64K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x10/12b; D/A 2x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	144-LQFP
Supplier Device Package	144-LFQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f56217bdfb-v0

Table 1.1 Outline of Specifications (3 / 4)

Classification	Module/Function	Description
Timers	Programmable pulse generator	・(4 bits x 4 groups) x 2 units ・Pulse output with the MTU output as a trigger ・Maximum of 32-bit pulse output possible
	8-bit timers	・(8 bits x 2 channels) x 2 units ・Select from among seven internal clock signals (PCLK, PCLK/2, PCLK/8, PCLK/32, PCLK/64, PCLK/1024, PCLK/8192) and one external clock signal ・Capable of output of pulse trains with desired duty cycles or of PWM signals ・The 2 channels of each unit can be cascaded to create a 16-bit timer ・Generation of triggers for A/D converter conversion ・Capable of generating baud-rate clocks for SCI5 and SCI6
	Compare match timer	・(16 bits x 2 channels) x 2 units ・Select from among four internal clock signals (PCLK/8, PCLK/32, PCLK/128, PCLK/512)
	Watchdog timer	・8 bits x 1 channel ・Select from among eight counter-input clock signals (PCLK/4, PCLK/64, PCLK/128, PCLK/512, PCLK/2048, PCLK/8192, PCLK/32768, PCLK/131072) ・Switchable between watchdog timer mode and interval timer mode
	Independent watchdog timer	・14 bits x 1 channel ・Counter-input clock: Dedicated on-chip oscillator
Realtime clock		・Clock source: Subclock ・Time/calendar Interrupt sources: Alarm interrupt, periodic interrupt, and carry interrupt
Communication function	Ethernet controller	・Input and output of Ethernet/IEEE 802.3 frames ・Transfer at 10 or 100 Mbps ・Full- and half-duplex modes ・MII (Media Independent Interface) or RMII (Reduced Media Independent Interface) as defined in IEEE 802.3u ・Detection of Magic Packets™* or output of a "wake-on-LAN" signal (WOL) ・Compliance with flow control as defined in IEEE 802.3x standards Note: * Magic Packet™ is a registered trademark of Advanced Micro Devices, Inc.
	DMA controller for Ethernet controller	・Alleviation of CPU loads by the descriptor control method ・Transmission FIFO: 2 Kbytes; Reception FIFO: 2 Kbytes
	USB 2.0 host/ function module	・Includes a UDC (USB Device Controller) and transceiver for USB 2.0 ・Single port (176-pin products: two ports) ・Compliance with the USB 2.0 specification ・Transfer rate: Full speed (12 Mbps) ・Self-power mode and bus power are selectable ・OTG (On the Go) operation is possible ・Incorporates 2 Kbytes of RAM as a transfer buffer
	Serial communications interfaces	・6 channels ・Serial communications modes: Asynchronous, clock synchronous, and smart-card interface ・Multi-processor communications function ・On-chip baud rate generator allows selection of the desired bit rate ・Choice of LSB-first or MSB-first transfer ・Average transfer rate clock can be input from TMR timers for SCI5 and SCI6

1.2 List of Products

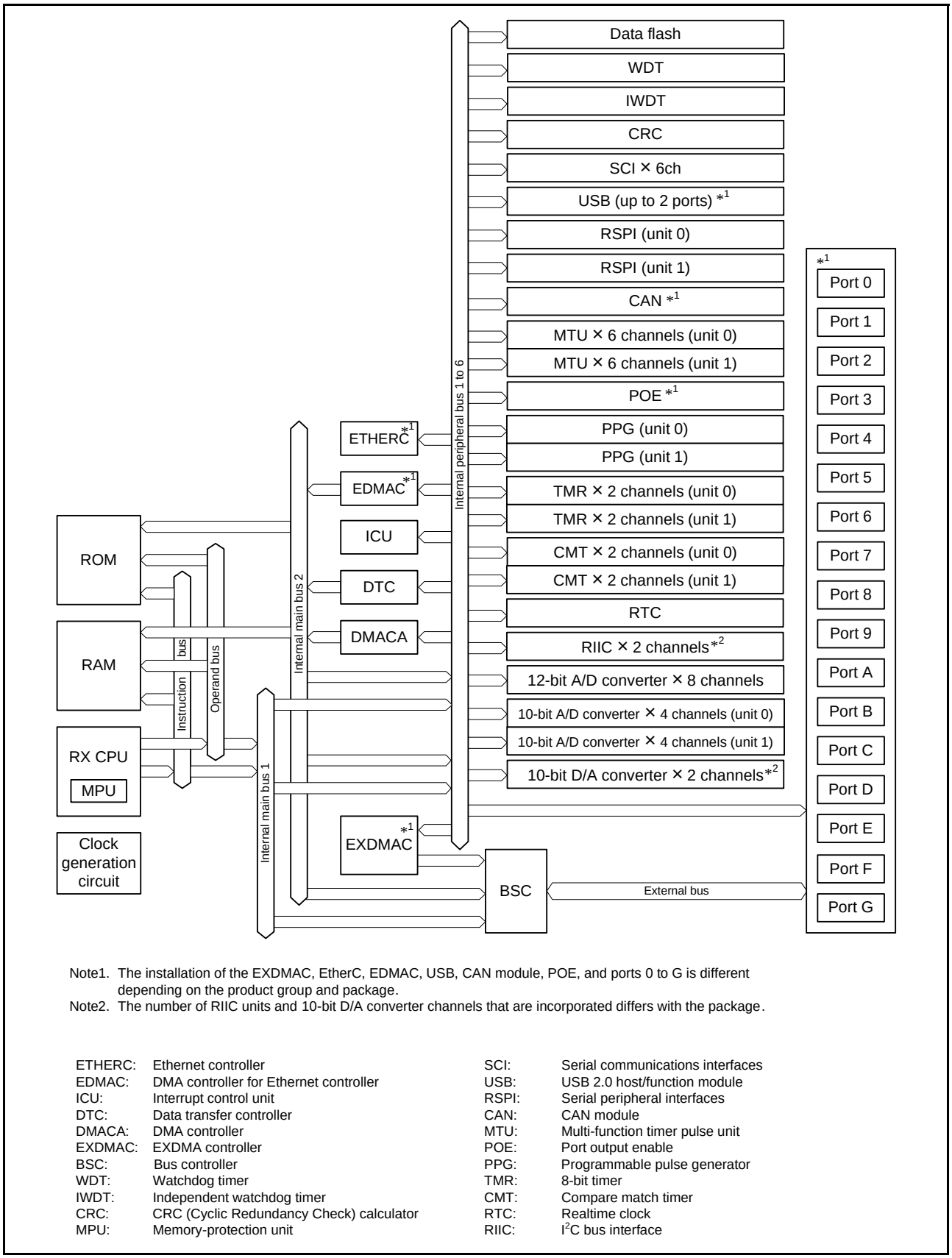
Table 1.3 is a list of products, and Figure 1.1 shows how to read the product part no.

Table 1.3 List of Products

Group	Part No.	Package	ROM Capacity	RAM Capacity	Data Flash	Operating Frequency (Max.)
RX62N	R5F562N8BDBG	PLBG0176GA-A	512 Kbytes	96 Kbytes	32 Kbytes	100 MHz
	R5F562N8BDLE	PTLG0145JB-A	512 Kbytes	96 Kbytes	32 Kbytes	100 MHz
	R5F562N8BDFB	PLQP0144KA-A	512 Kbytes	96 Kbytes	32 Kbytes	100 MHz
	R5F562N8BDFP	PLQP0100KB-A	512 Kbytes	96 Kbytes	32 Kbytes	100 MHz
	R5F562N7BDBG	PLBG0176GA-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz
	R5F562N7BDLE	PTLG0145JB-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz
	R5F562N7BDFB	PLQP0144KA-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz
	R5F562N7BDFP	PLQP0100KB-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz
	R5F562N8ADBG	PLBG0176GA-A	512 Kbytes	96 Kbytes	32 Kbytes	100 MHz
	R5F562N8ADLE	PTLG0145JB-A	512 Kbytes	96 Kbytes	32 Kbytes	100 MHz
	R5F562N8ADFB	PLQP0144KA-A	512 Kbytes	96 Kbytes	32 Kbytes	100 MHz
	R5F562N8ADFP	PLQP0100KB-A	512 Kbytes	96 Kbytes	32 Kbytes	100 MHz
	R5F562N7ADBG	PLBG0176GA-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz
	R5F562N7ADLE	PTLG0145JB-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz
	R5F562N7ADFB	PLQP0144KA-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz
	R5F562N7ADFP	PLQP0100KB-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz
RX621	R5F56218BDBG	PLBG0176GA-A	512 Kbytes	96 Kbytes	32 Kbytes	100 MHz
	R5F56218BDLE	PTLG0145JB-A	512 Kbytes	96 Kbytes	32 Kbytes	100 MHz
	R5F56218BDFB	PLQP0144KA-A	512 Kbytes	96 Kbytes	32 Kbytes	100 MHz
	R5F56218BDFP	PLQP0100KB-A	512 Kbytes	96 Kbytes	32 Kbytes	100 MHz
	R5F56218BDLD	PTLG0085JA-A	512 Kbytes	96 Kbytes	32 Kbytes	100 MHz
	R5F56217BDBG	PLBG0176GA-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz
	R5F56217BDLE	PTLG0145JB-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz
	R5F56217BDFB	PLQP0144KA-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz
	R5F56217BDFP	PLQP0100KB-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz
	R5F56217BDLD	PTLG0085JA-A	384 Kbytes	64 Kbytes	32 Kbytes	100 MHz
	R5F56216BDBG	PLBG0176GA-A	256 Kbytes	64 Kbytes	32 Kbytes	100 MHz
	R5F56216BDLE	PTLG0145JB-A	256 Kbytes	64 Kbytes	32 Kbytes	100 MHz
	R5F56216BDFB	PLQP0144KA-A	256 Kbytes	64 Kbytes	32 Kbytes	100 MHz
	R5F56216BDFP	PLQP0100KB-A	256 Kbytes	64 Kbytes	32 Kbytes	100 MHz
	R5F56216BDLD	PTLG0085JA-A	256 Kbytes	64 Kbytes	32 Kbytes	100 MHz

1.3 Block Diagram

Figure 1.2 shows a block diagram.



Note1. The installation of the EXDMAC, EtherC, EDMAC, USB, CAN module, POE, and ports 0 to G is different depending on the product group and package.
Note2. The number of RIIC units and 10-bit D/A converter channels that are incorporated differs with the package.

ETHERC:	Ethernet controller	SCI:	Serial communications interfaces
EDMAC:	DMA controller for Ethernet controller	USB:	USB 2.0 host/function module
ICU:	Interrupt control unit	RSPI:	Serial peripheral interfaces
DTC:	Data transfer controller	CAN:	CAN module
DMACA:	DMA controller	MTU:	Multi-function timer pulse unit
EXDMAC:	EXDMA controller	POE:	Port output enable
BSC:	Bus controller	PPG:	Programmable pulse generator
WDT:	Watchdog timer	TMR:	8-bit timer
IWDT:	Independent watchdog timer	CMT:	Compare match timer
CRC:	CRC (Cyclic Redundancy Check) calculator	RTC:	Realtime clock
MPU:	Memory-protection unit	RIIC:	I^2C bus interface

Figure 1.2 Block Diagram

Table 1.4 List of Pins and Pin Functions (176-Pin LFBGA) (2 / 6)

Pin No. 176-Pin LFBGA	Power Supply Clock System Control	I/O Port	External Bus EXDMAC	ETHERC EDMAC	USB	Timers (MTU, TMR, PPG, POE, WDT)	Communi-cation (SCI, CAN, RSPI, RIIC)	Others
C6	VCC							
C7		P92	D18/A18-B					
C8		P94	D20/A20-B					
C9	VCC							
C10		PD5	D5			MTIC5W-B/ POE2#		
C11	VCC							
C12		PE0	D8				SSLB1-B	
C13		PE3	D11			POE8#		
C14		PE5	D13				RSPCKB-B	IRQ5-A
C15		PE6	D14				MOSIB-B	IRQ6-A
D1	EMLE							
D2		P01				TMCI0-A	RxD6-A	IRQ9-A
D3	VCC							
D4		P41						IRQ9-B/AN1
D5		P43						IRQ11-B/AN3
D6	VSS							
D7		P93	D19/A19-B					
D8		P95	D21/A21-B					
D9	VSS							
D10		PG1	D25					
D11	VSS							
D12	VSS							
D13		PE4	D12				SSLB0-B	
D14		PE7	D15				MISOB-B	IRQ7-A
D15		P65	CS5#-A/ CKE					
E1	XCIN							
E2	CNVSS							
E3	BSCANP							
E4	VSS							
E12		PG2	D26					TRDATA0
E13	VCC							
E14		P66	CS6#-A/ DQM0					
E15		P67	CS7#-A/ DQM1					
F1	XCOUT							
F2						WDTOVF#		
F3	VCL							
F4	VSS							
F12		PG4	D28					TRSYNC
F13		PG3	D27					TRDATA1
F14		PA0	A0/BC0#/ DQM2			MTIOC6A/ PO16	SSLA1-B	

Table 1.5 List of Pins and Pin Functions (145-Pin TFLGA) (1 / 5)

Pin No. 145-Pin TFLGA	Power Supply Clock System Control	I/O Port	External Bus EXDMAC	ETHERC EDMAC	USB	Timers (MTU, TMR, PPG, POE, WDT)	Communi-cation (SCI, CAN, RSPI, RIIC)	Others
A1	AVSS							
A2	AVCC							
A3	VREFL							
A4		P42						IRQ10-B/AN2
A5		P44						IRQ12/AN4
A6		P47						IRQ15-B/AN7
A7		P91	A17-B					
A8		PD0	D0			POE7#		
A9		PD3	D3			MTIC11V-B/ POE4#		
A10		PD6	D6			MTIC5V/ POE1#		
A11		P60	CS0#-A					
A12		P62	CS2#-A/ RAS#					
A13		P64	CS4#-A/ WE#					
B1		P03						IRQ11-A/DA0
B2		P07						IRQ15-A/ ADTRG0#-A
B3	VREFH							
B4		P40						IRQ8-B/AN0
B5		P45						IRQ13-B/AN5
B6		P90	A16-B					
B7		PD1	D1			POE6#		
B8		PD5	D5			MTIC5W/ POE2#		
B9	VSS							
B10		PE0	D8				SSLB1-B	
B11		PE2	D10			POE9#	SSLB3-B	
B12		PE1	D9				SSLB2-B	
B13		PE4	D12				SSLB0-B	
C1		P01				TMCI0-A	RxD6-A	IRQ9-A
C2		P05						IRQ13-A/DA1
C3	VSS							
C4		P41						IRQ9-B/AN1
C5		P46						IRQ14/AN6
C6		P92	A18-B					
C7		PD2	D2			MTIC11W-B/ POE5#		
C8		PD7	D7			MTIC5U/ POE0#		
C9		P61	CS1#-A/ SDCS#					

Table 1.9 Pin Functions (2 / 7)

Classifications	Pin Name	I/O	Description
Bus control	RD#	Output	Strobe signal which indicates that reading from the external bus interface space is in progress.
	WR#	Output	Strobe signal which indicates that writing to the external bus interface space is in progress, in 1-write strobe mode.
	WR0# to WR3#	Output	Strobe signals which indicate that any group of data bus pins (D7 to D0, D15 to D8, D23 to D16, and D31 to D24) is valid in writing to the external bus interface space, in byte strobe mode.
	BC0# to BC3#	Output	Strobe signals which indicate that any group of data bus pins (D7 to D0, D15 to D8, D23 to D16, and D31 to D24) is valid in access to the external bus interface space, in 1-write strobe mode.
	WE#	Output	Output pin for SDRAM write enable signals.
	CAS#	Output	Output pin for SDRAM column address strobe signals.
	RAS#	Output	Output pin for SDRAM row address strobe signals.
	CKE	Output	Output pin for SDRAM clock enable signals.
	DQM0 to DQM34	Output	Output pins for SDRAM I/O data mask enable signals.
	SDCS#	Output	Output pin for SDRAM chip select signals.
	CS0#-A/CS0#-B CS1#-A/CS1#-B/CS1#-C CS2#-A/CS2#-B/CS2#-C CS3#-A/CS3#-B/CS3#-C CS4#-A/CS4#-B/CS4#-C CS5#-A/CS5#-B/CS5#-C CS6#-A/CS6#-B/CS6#-C CS7#-A/CS7#-B/CS7#-C	Output	Select signals for areas 0 to 7.
	WAIT#-A/WAIT#-B/ WAIT#-C/WAIT#-D	Input	Input pins for wait request signals in access to the external space.
EXDMA controller	EDREQ0-A/EDREQ0-B/ EDREQ0-C	Input	Input pins for external DMA transfer requests of channel 0.
	EDREQ1-A/EDREQ1-B/ EDREQ1-C	Input	Input pins for external DMA transfer requests of channel 1.
	EDACK0-A/EDACK0-B/ EDACK0-C	Output	Output pins for single address transfer acknowledge signals of channel 0.
	EDACK1-A/EDACK1-B/ EDACK1-C	Output	Output pins for single address transfer acknowledge signals of channel 1.
Interrupt	NMI	Input	Non-maskable interrupt request signal.
	IRQ0-A/IRQ0-B IRQ1-A/IRQ1-B IRQ2-A/IRQ2-B IRQ3-A/IRQ3-B IRQ4-A/IRQ4-B IRQ5-A/IRQ5-B IRQ6-A/IRQ6-B IRQ7-A/IRQ7-B IRQ8-A/IRQ8-B IRQ9-A/IRQ9-B IRQ10-A/IRQ10-B IRQ11-A/IRQ11-B IRQ12 IRQ13-A/IRQ13-B IRQ14 IRQ15-A/IRQ15-B	Input	Interrupt request signals.

Table 1.9 Pin Functions (4 / 7)

Classifications	Pin Name	I/O	Description
8-bit timer	TMO0 to TMO3	Output	Output pins for the compare match signals.
	TMCI0-A/TMCI0-B TMCI1-A/TMCI1-B TMCI2-A/TMCI2-B TMCI3-A/TMCI3-B	Input	Input pins for the external clock signals that drive for the counters.
	TMRI0-A/TMRI0-B TMRI1 TMRI2 TMRI3-A/TMRI3-B	Input	Input pins for the counter-reset signals.
Watchdog timer	WDTOVF#	Output	Output pin for the counter-overflow signal in watchdog-timer mode.
Serial communications interface	TxD0 TxD1-A/TxD1-B TxD2-A/TxD2-B TxD3-A/TxD3-B TxD5 TxD6-A/TxD6-B	Output	Output pins for data transmission.
	RxD0 RxD1-A/RxD1-B RxD2-A/RxD2-B RxD3-A/RxD3-B RxD5 RxD6-A/RxD6-B	Input	Input pins for data reception.
	SCK0 SCK1-A/SCK1-B SCK2-A/SCK2-B SCK3-A/SCK3-B SCK5 SCK6-A/SCK6-B	I/O	Input/output pins for clock signals.
I^2C bus interface	SCL0, SCL1	I/O	Input/output pins for I^2C bus interface clocks. Bus can be directly driven by the NMOS open drain output.
	SDA0, SDA1	I/O	Input/output pins for I^2C bus interface data. Bus can be directly driven by the NMOS open drain output.

Table 1.9 Pin Functions (5 / 7)

Classifications	Pin Name	I/O	Description
Ethernet controller	REF50CK	Input	50-MHz reference clock. This pin inputs reference signals for transmission/reception timings in RMII mode.
	RMII_CRS_DV	Input	Indicates that there are carrier detection signals and valid receive data on RMII_RXD1 and RMII_RXD0 in RMII mode.
	RMII_TXD0, RMII_TXD1	Output	2-bit transmit data in RMII mode.
	RMII_RXD0, RMII_RXD1	Input	2-bit receive data in RMII mode.
	RMII_TXD_EN	Output	Output pin for data transmit enable signals in RMII mode.
	RMII_RX_ER	Input	Indicates an error has occurred during reception of data in RMII mode.
	ET_CRS	Input	Carrier detection/data reception enable pin.
	ET_RX_DV	Input	Indicates that there are valid receive data on ET_ERXD3 to ET_ERXD0.
	ET_EXOUT	Output	General-purpose external output pin.
	ET_LINKSTA	Input	Inputs link status from the PHY-LSI.
	ET_ETXD0 to ET_ETXD3	Output	4 bits of MII transmit data.
	ET_ERXD0 to ET_ERXD3	Input	4 bits of MII receive data.
	ET_TX_EN	Output	Transmit enable pin. Indicates that transmit data is ready on ET_ETXD3 to ET_ETXD0.
	ET_TX_ER	Output	Transmit error pin. Notifies the PHY_LSI of an error during transmission.
	ET_RX_ER	Input	Receive error pin. Recognizes an error during reception.
	ET_TX_CLK	Input	Transmit clock pin. This pin inputs reference signals for output timings from ET_TX_EN, ET_ETXD3 to ET_ETXD0, and ET_TX_ER.
	ET_RX_CLK	Input	Receive clock pin. This pin inputs reference signals for input timings to ET_RX_DV, ET_ERXD3 to ET_ERXD0, and ET_RX_ER.
	ET_COL	Input	Inputs collision detection signals.
	ET_WOL	Output	Receives Magic Packets™
	ET_MDC	Output	Outputs reference clock signals for information transfer via ET_MDIO.
	ET_MDIO	I/O	These pins carry bidirectional signals for the exchange of management information between the RX62N Group and the PHY-LSI.

Table 4.1 List of I/O Registers (Address Order) (24 / 36)

Address	Module Abbreviation	Register Name	Register Abbreviation	Number of Bits	Access Size	Number of Access Cycles
0008 8A4Ah	MTU10	Timer A/D converter start request cycle set buffer register B	TADCOBRB	16	16	2 to 3 PCLK*8
0008 8A60h	MTUB	Timer waveform control register	TWCR	8	8	2 to 3 PCLK*8
0008 8A80h	MTUB	Timer start register	TSTR	8	8	2 to 3 PCLK*8
0008 8A81h	MTUB	MTUB Timer synchronous register	TSYR	8	8	2 to 3 PCLK*8
0008 8A84h	MTUB	MTUB Timer read/write enable register	TRWER	8	8	2 to 3 PCLK*8
0008 8B00h	MTU6	Timer control register	TCR	8	8	2 to 3 PCLK*8
0008 8B01h	MTU6	Timer mode register	TMDR	8	8	2 to 3 PCLK*8
0008 8B02h	MTU6	Timer I/O control register H	TIORH	8	8	2 to 3 PCLK*8
0008 8B03h	MTU6	Timer I/O control register L	TIORL	8	8	2 to 3 PCLK*8
0008 8B04h	MTU6	Timer interrupt enable register	TIER	8	8	2 to 3 PCLK*8
0008 8B05h	MTU6	Timer status register	TSR	8	8	2 to 3 PCLK*8
0008 8B06h	MTU6	Timer counter	TCNT	16	16	2 to 3 PCLK*8
0008 8B08h	MTU6	Timer general register A	TGRA	16	16	2 to 3 PCLK*8
0008 8B0Ah	MTU6	Timer general register B	TGRB	16	16	2 to 3 PCLK*8
0008 8B0Ch	MTU6	Timer general register C	TGRC	16	16	2 to 3 PCLK*8
0008 8B0Eh	MTU6	Timer general register D	TGRD	16	16	2 to 3 PCLK*8
0008 8B20h	MTU6	Timer general register E	TGRE	16	16	2 to 3 PCLK*8
0008 8B22h	MTU6	Timer general register F	TGRF	16	16	2 to 3 PCLK*8
0008 8B24h	MTU6	Timer interrupt enable register 2	TIER2	8	8	2 to 3 PCLK*8
0008 8B26h	MTU6	Timer buffer operation transfer mode register	TBTM	8	8	2 to 3 PCLK*8
0008 8B80h	MTU7	Timer control register	TCR	8	8	2 to 3 PCLK*8
0008 8B81h	MTU7	Timer mode register	TMDR	8	8	2 to 3 PCLK*8
0008 8B82h	MTU7	Timer I/O control register	TIOR	8	8	2 to 3 PCLK*8
0008 8B84h	MTU7	Timer interrupt enable register	TIER	8	8	2 to 3 PCLK*8
0008 8B85h	MTU7	Timer status register	TSR	8	8	2 to 3 PCLK*8
0008 8B86h	MTU7	Timer counter	TCNT	16	16	2 to 3 PCLK*8
0008 8B88h	MTU7	Timer general register A	TGRA	16	16	2 to 3 PCLK*8
0008 8B8Ah	MTU7	Timer general register B	TGRB	16	16	2 to 3 PCLK*8
0008 8B90h	MTU7	Timer input capture control register	TICCR	8	8	2 to 3 PCLK*8
0008 8C00h	MTU8	Timer control register	TCR	8	8	2 to 3 PCLK*8
0008 8C01h	MTU8	Timer mode register	TMDR	8	8	2 to 3 PCLK*8
0008 8C02h	MTU8	Timer I/O control register	TIOR	8	8	2 to 3 PCLK*8
0008 8C04h	MTU8	Timer interrupt enable register	TIER	8	8	2 to 3 PCLK*8
0008 8C05h	MTU8	Timer status register	TSR	8	8	2 to 3 PCLK*8
0008 8C06h	MTU8	Timer counter	TCNT	16	16	2 to 3 PCLK*8
0008 8C08h	MTU8	Timer general register A	TGRA	16	16	2 to 3 PCLK*8
0008 8C0Ah	MTU8	Timer general register B	TGRB	16	16	2 to 3 PCLK*8
0008 8C80h	MTU11	Timer counter U	TCNTU	16	16	2 to 3 PCLK*8
0008 8C82h	MTU11	Timer general register U	TGRU	16	16	2 to 3 PCLK*8
0008 8C84h	MTU11	Timer control register U	TCRU	8	8	2 to 3 PCLK*8
0008 8C86h	MTU11	Timer I/O control register U	TIORU	8	8	2 to 3 PCLK*8
0008 8C90h	MTU11	Timer counter V	TCNTV	16	16	2 to 3 PCLK*8
0008 8C92h	MTU11	Timer general register V	TGRV	16	16	2 to 3 PCLK*8

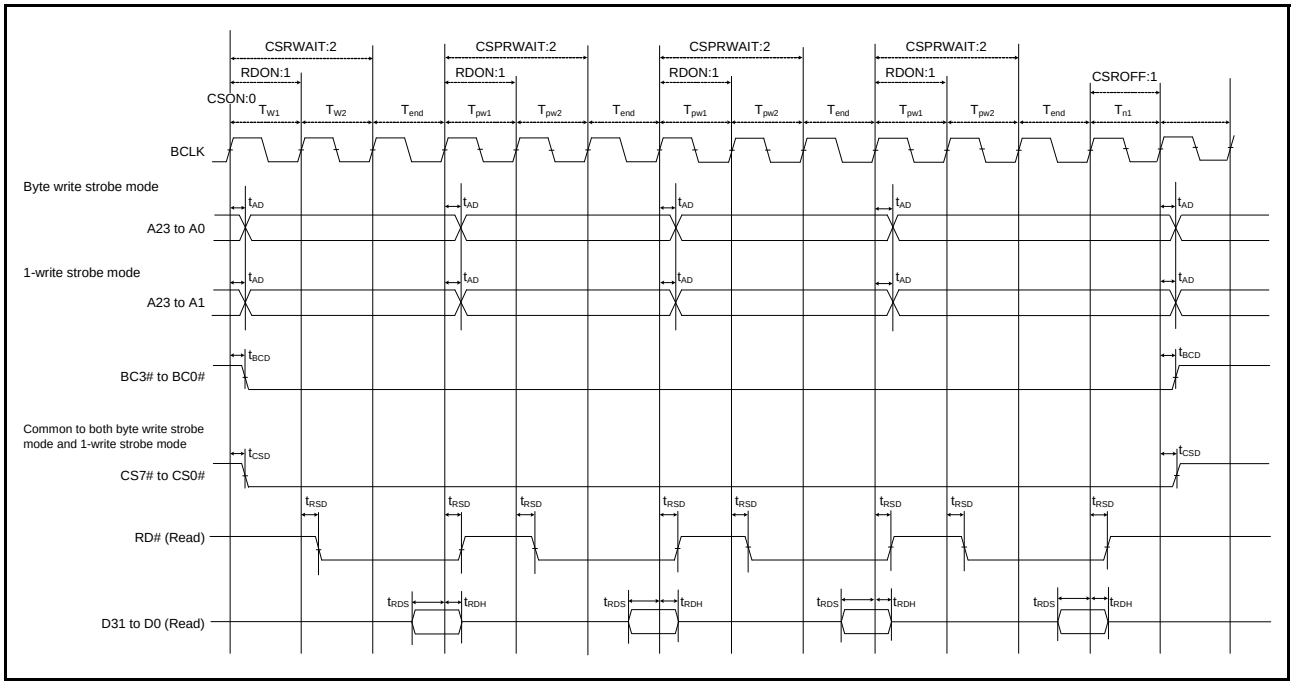


Figure 5.12 External Bus Timing/Page Read Cycle (Bus Clock Synchronized)

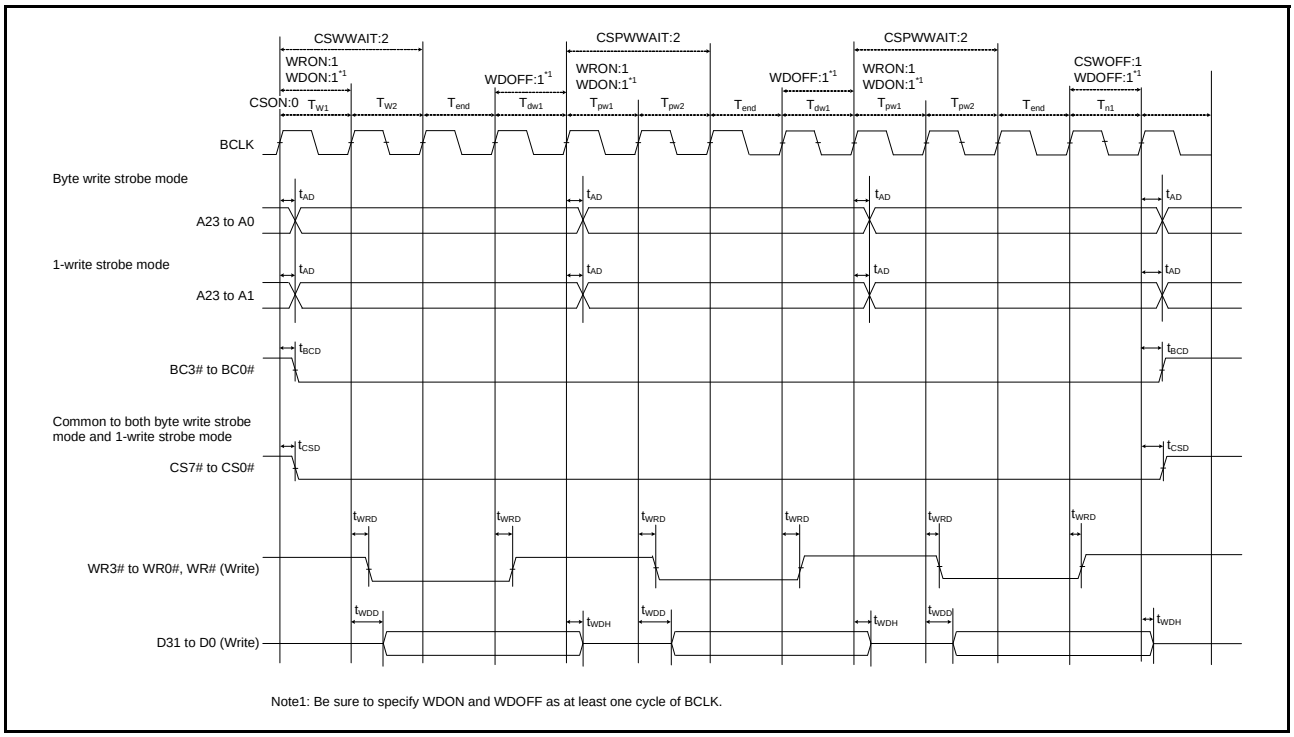


Figure 5.13 External Bus Timing/Page Write Cycle (Bus Clock Synchronized)

5.3.4 EXDMAC Timing

Table 5.12 EXDMAC Timing

Conditions: VCC = PLLVCC = AVCC = VCC_USB = 2.7 to 3.6 V, VREFH = 2.7 V to AVCC
VSS = PLLVSS = AVSS = VREFL = VSS_USB = 0 V
ICLK = 8 to 100 MHz, PCLK = 8 to 50 MHz, BCLK = 8 to 100 MHz, SDCLK = 8 to 50 MHz
T_a = -40 to +85°C

Item		Symbol	Min.	Max.	Unit	Test Conditions
EXDMAC	EDREQ setup time	t_{EDRQS}	20	—	ns	Figure 5.22
	EDREQ hold time	t_{EDRQH}	5	—	ns	
	EDACK delay time	t_{EDACD}	—	15	ns	Figure 5.23 and Figure 5.24

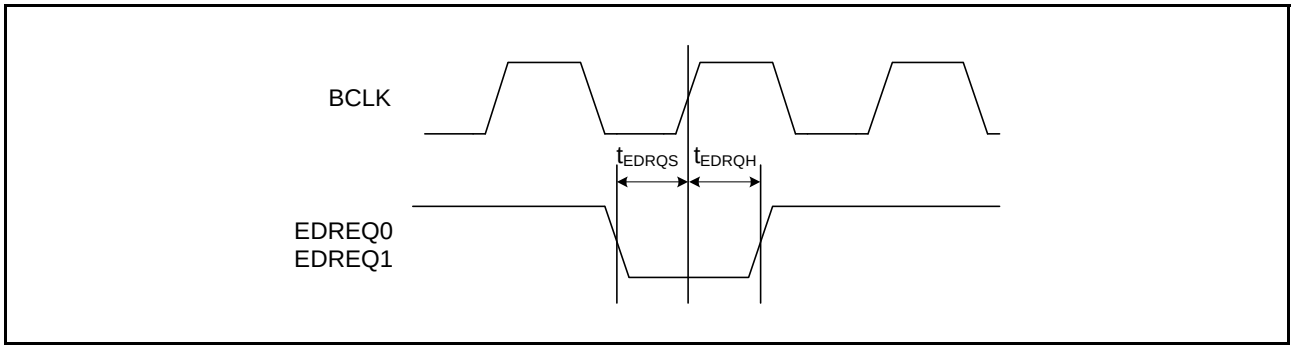


Figure 5.22 EDREQ0 and EDREQ1 Input Timing

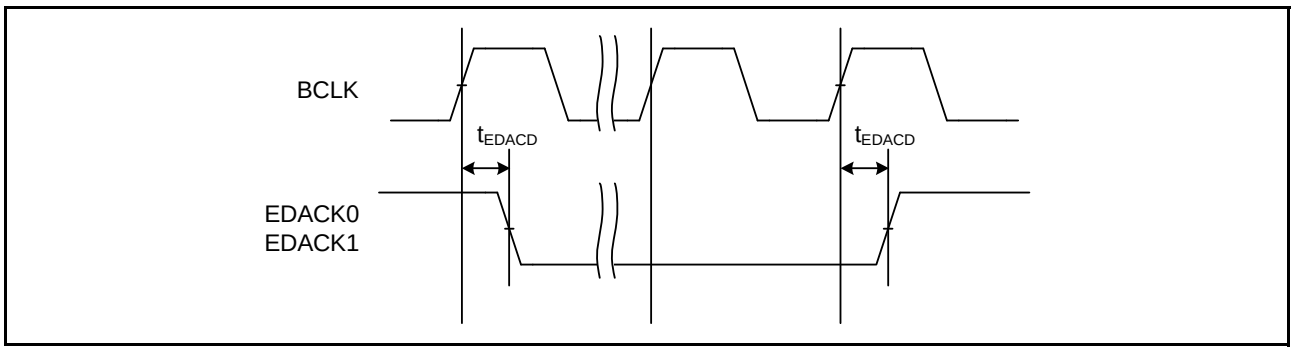


Figure 5.23 EDACK0 and EDACK1 Single-Address Transfer Timing (for a CS Area)

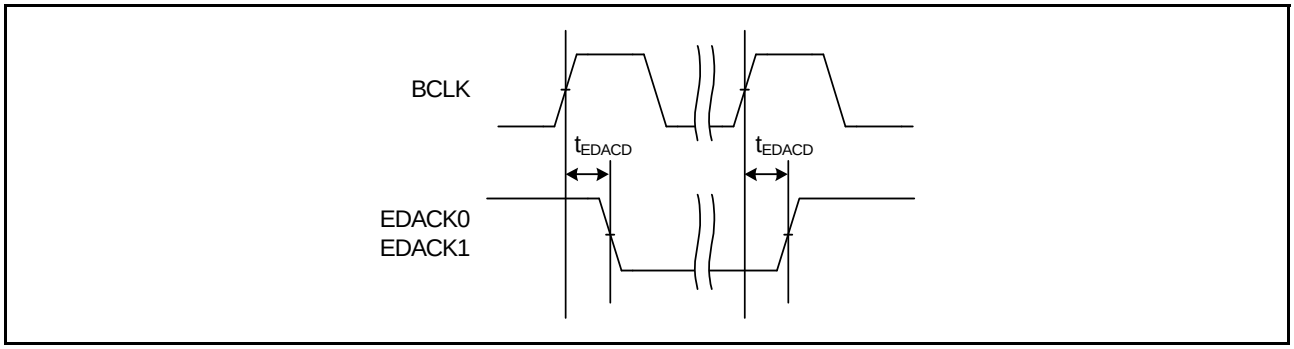


Figure 5.24 EDACK0 and EDACK1 Single-Address Transfer Timing (for SDRAM)

5.3.5 Timing of On-Chip Peripheral Modules

Table 5.13 Timing of On-Chip Peripheral Modules (1)

Conditions: VCC = PLLVCC = AVCC = VCC_USB = 2.7 to 3.6 V, VREFH = 2.7 V to AVCC
VSS = PLLVSS = AVSS = VREFL = VSS_USB = 0 V
PCLK = 8 to 50 MHz
T_a = -40 to +85°C

Item			Symbol	Min.	Max.	Unit	Test Conditions
I/O ports	Output data delay time		t_{PWD}	—	40	ns	Figure 5.25
	Input data setup time		t_{PRS}	25	—	ns	
	Input data hold time		t_{PRH}	25	—	ns	
MTU2	Output compare output delay time		t_{TOCD}	—	40	ns	Figure 5.26
	Input capture input setup time		t_{TICS}	20	—	ns	
	Input capture input pulse width (single-edge setting)		t_{TICW}	1.5 × t_{Pcyc}	—	ns	
	Input capture input pulse width (both-edge setting)		t_{TICW}	2.5 × t_{Pcyc}	—	ns	
	Timer input setup time		t_{TCKS}	20	—	ns	Figure 5.27
	Timer clock pulse width (single-edge setting)		$t_{TCKWH/L}$	1.5 × t_{Pcyc}	—	ns	
	Timer clock pulse width (both-edge setting)		$t_{TCKWH/L}$	2.5 × t_{Pcyc}	—	ns	
	Timer clock pulse width (phase counting mode)		$t_{TCKWH/L}$	2.5 × t_{Pcyc}	—	ns	
POE2	POE# input setup time		t_{POES}	50	—	ns	Figure 5.28
	POE# input pulse width		t_{POEW}	1.5 × t_{Pcyc}	—	ns	
PPG	Pulse output delay time		t_{POD}	—	40	ns	Figure 5.29
8-bit timer	Timer output delay time		t_{TMOD}	—	40	ns	Figure 5.30
	Timer reset input setup time		t_{TMRS}	25	—	ns	Figure 5.31
	Timer clock input setup time		t_{TMCS}	25	—	ns	Figure 5.32
	Timer clock pulse width	Single-edge setting	t_{TMCWH}	1.5 × t_{Pcyc}	—	ns	
		Both-edge setting	t_{TMCWL}	2.5 × t_{Pcyc}	—	ns	
WDT	Overflow output delay time		t_{WOVD}	—	40	ns	Figure 5.33

Table 5.14 Timing of On-Chip Peripheral Modules (4)

Conditions: VCC = PLLVCC = AVCC = VCC_USB = 2.7 to 3.6 V, VREFH = 2.7 V to AVCC
VSS = PLLVSS = AVSS = VREFL = VSS_USB = 0 V
PCLK = 8 to 50 MHz
T_a = -40 to +85°C

Item			Symbol	Min.	Max.	Unit	Test Conditions
RSPI	Data input setup time	Master [176-pin LFBGA/ 145-pin TFLGA/ 144-pin LQFP]	t_{SU}	16	—	ns	Figure 5.39 to Figure 5.42
		Master [100-pin LQFP/ 85-pin TFLGA]		30	—		
		Slave		20-2 × t_{Pcyc}	—		
	Data input hold time	Master	t_H	0	—	ns	
		Slave		20+2 × t_{Pcyc}	—		
	SSL setup time	Master	t_{LEAD}	1	8	t_{SPcyc}	
		Slave		4	—	t_{Pcyc}	
	SSL hold time	Master	t_{LAG}	1	8	t_{SPcyc}	
		Slave		4	—	t_{Pcyc}	
	Data output delay time	Master [176-pin LFBGA/ 145-pin TFLGA/ 144-pin LQFP]	t_{OD}	—	20	ns	
		Master [100-pin LQFP/ 85-pin TFLGA]		—	30		
		Slave [176-pin LFBGA/ 145-pin TFLGA/ 144-pin LQFP]		—	3 × t_{Pcyc}+40		
		Slave [100-pin LQFP/ 85-pin TFLGA]		—	3 × t_{Pcyc}+50		

Note 1. tPcyc: PCLK cycle

Table 5.16 Timing of On-Chip Peripheral Modules (6)

Conditions: VCC = PLLVCC = AVCC = VCC_USB = 2.7 to 3.6 V, VREFH = 2.7 V to AVCC
VSS = PLLVSS = AVSS = VREFL = VSS_USB = 0 V
PCLK = 8 to 50 MHz
T_a = -40 to +85°C

Item		Symbol	Min.*1*2	Max.	Unit	Test Conditions
RIIC (Standard-mode, SMBus) ICFER.FMPE = 0	SCL input cycle time	t_{SCL}	6(12) × t_{IICcyc} + 1300	—	ns	Figure 5.43
	SCL input high pulse width	t_{SCLH}	3(6) × t_{IICcyc} + 300	—	ns	
	SCL input low pulse width	t_{SCLL}	3(6) × t_{IICcyc} + 300	—	ns	
	SCL, SDA input rising time	t_{Sr}	—	1000	ns	
	SCL, SDA input falling time	t_{Sf}	—	300	ns	
	SCL, SDA input spike pulse removal time	t_{SP}	0	1(4) × t_{IICcyc}	ns	
	SDA input bus free time	t_{BUF}	3(6) × t_{IICcyc} + 300	—	ns	
	Start condition input hold time	t_{STAH}	t_{IICcyc} + 300	—	ns	
	Re-start condition input setup time	t_{STAS}	1000	—	ns	
	Stop condition input setup time	t_{STOS}	1000	—	ns	
	Data input setup time	t_{SDAS}	t_{IICcyc} + 50	—	ns	
	Data input hold time	t_{SDAH}	0	—	ns	
	SCL, SDA capacitive load	C_b	—	400	pF	
RIIC (Fast-mode)	SCL input cycle time	t_{SCL}	6(12) × t_{IICcyc} + 600	—	ns	
	SCL input high pulse width	t_{SCLH}	3(6) × t_{IICcyc} + 300	—	ns	
	SCL input low pulse width	t_{SCLL}	3(6) × t_{IICcyc} + 300	—	ns	
	SCL, SDA input rising time	t_{Sr}	20+0.1C_b	300	ns	
	SCL, SDA input falling time	t_{Sf}	20+0.1C_b	300	ns	
	SCL, SDA input spike pulse removal time	t_{SP}	0	1(4) × t_{IICcyc}	ns	
	SDA input bus free time	t_{BUF}	3(6) × t_{IICcyc} + 300	—	ns	
	Start condition input hold time	t_{STAH}	t_{IICcyc} + 300	—	ns	
	Re-start condition input setup time	t_{STAS}	300	—	ns	
	Stop condition input setup time	t_{STOS}	300	—	ns	
	Data input setup time	t_{SDAS}	t_{IICcyc} + 50	—	ns	
	Data input hold time	t_{SDAH}	0	—	ns	
	SCL, SDA capacitive load	C_b	—	400	pF	

Note: t_{IICcyc}: RIIC internal reference clock (IICφ) cycles
Note 1. The value in parentheses is used when ICMR3.NF[1:0] are set to 11b while a digital filter is enabled with ICFER.NFE = 1.
Note 2. C_b indicates the total capacity of the bus line.

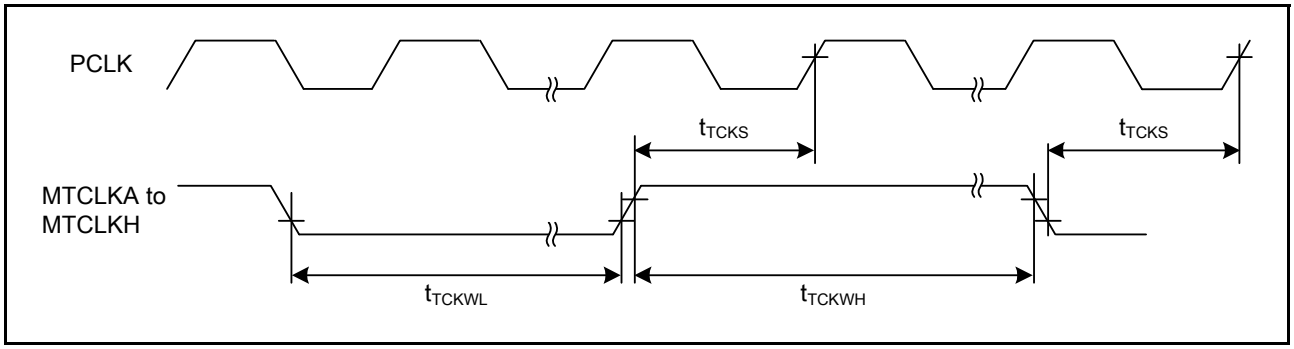


Figure 5.27 MTU2 Clock Input Timing

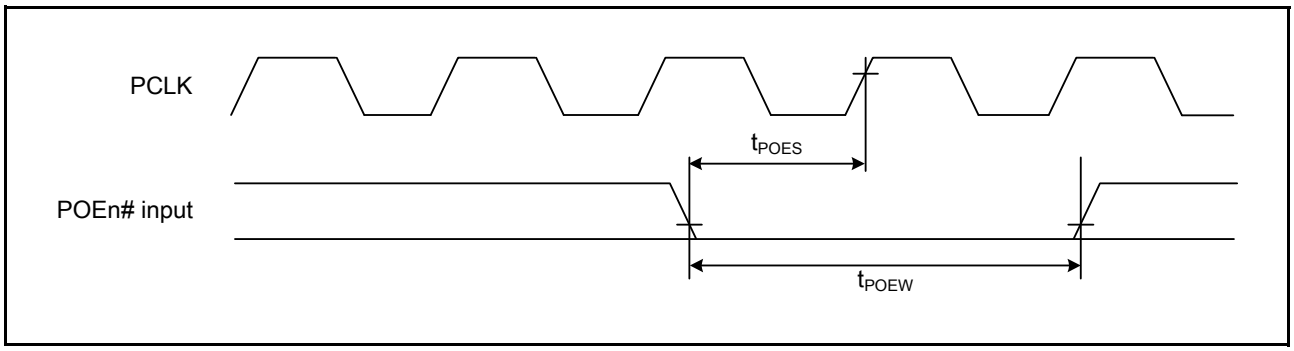


Figure 5.28 POE# Input Timing

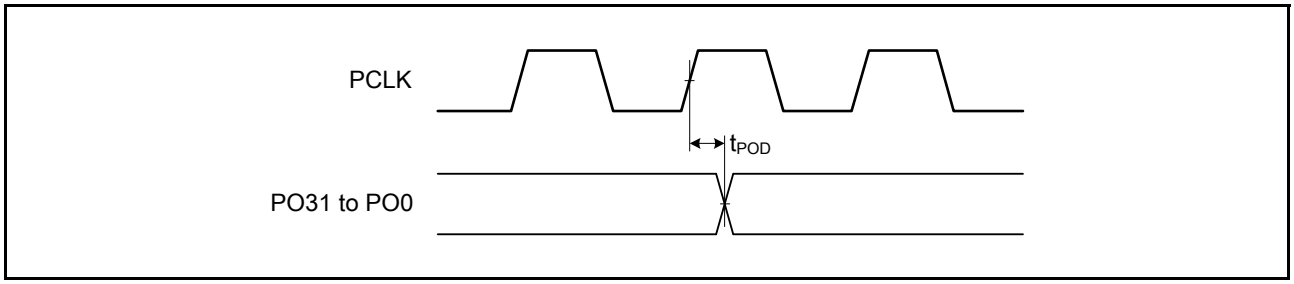


Figure 5.29 PPG Output Timing

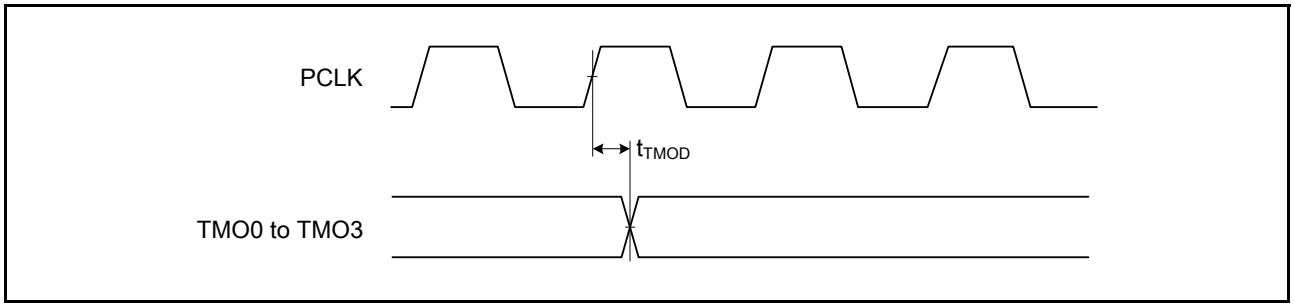


Figure 5.30 8-Bit Timer Output Timing

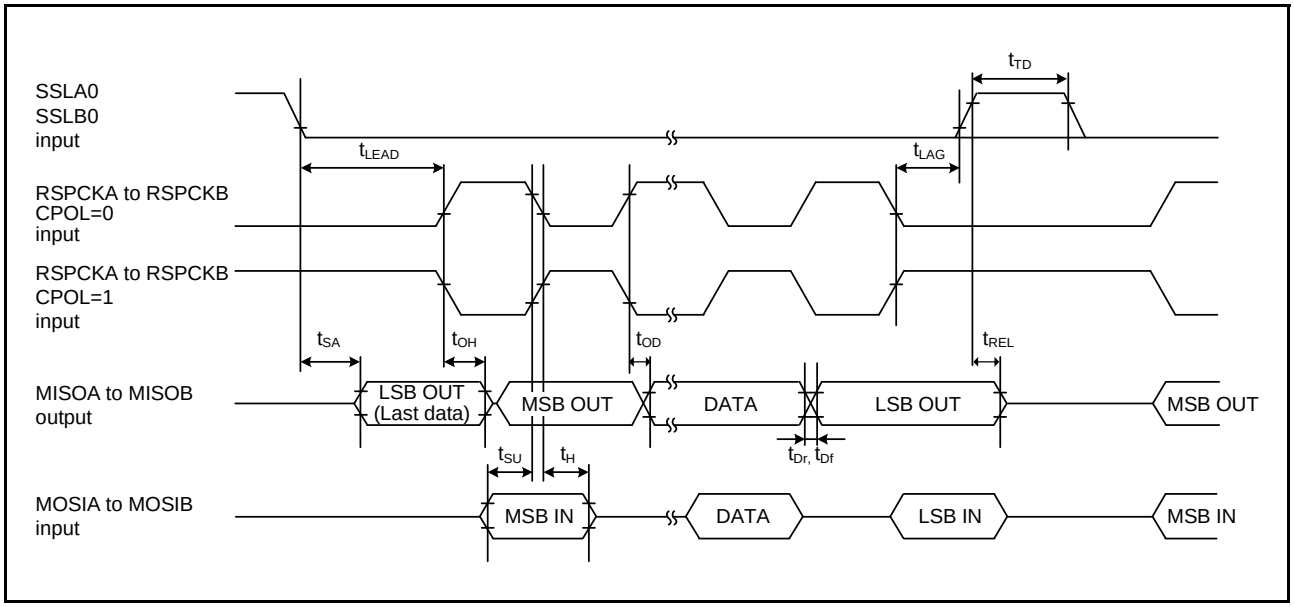


Figure 5.42 RSPI Timing (Slave, CPHA = 1)

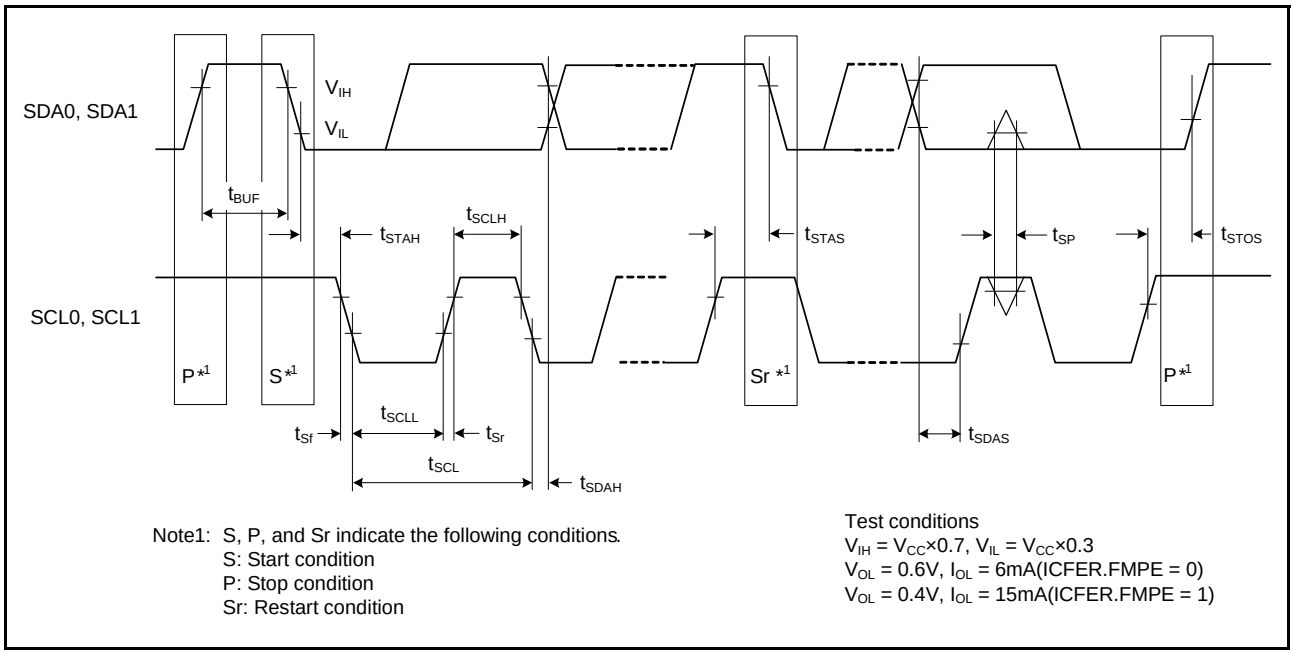


Figure 5.43 I2C Bus Interface Input/Output Timing

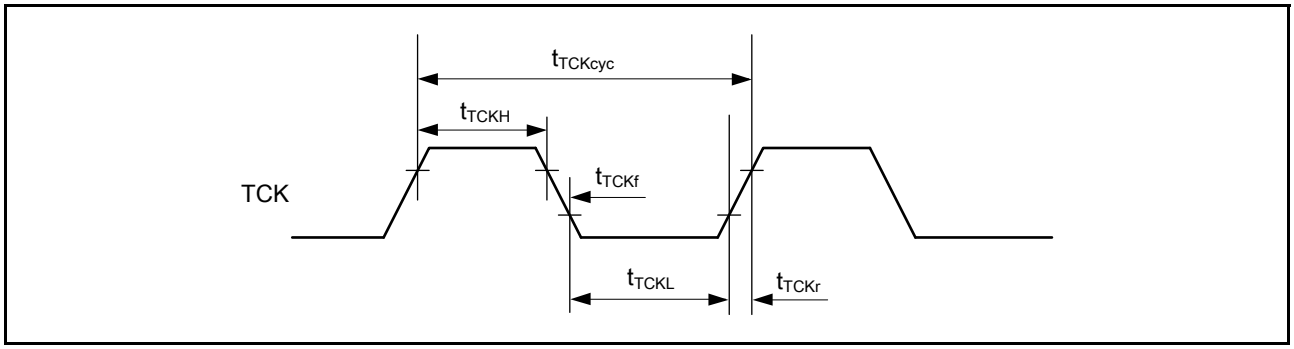


Figure 5.58 Boundary Scan TCK Timing

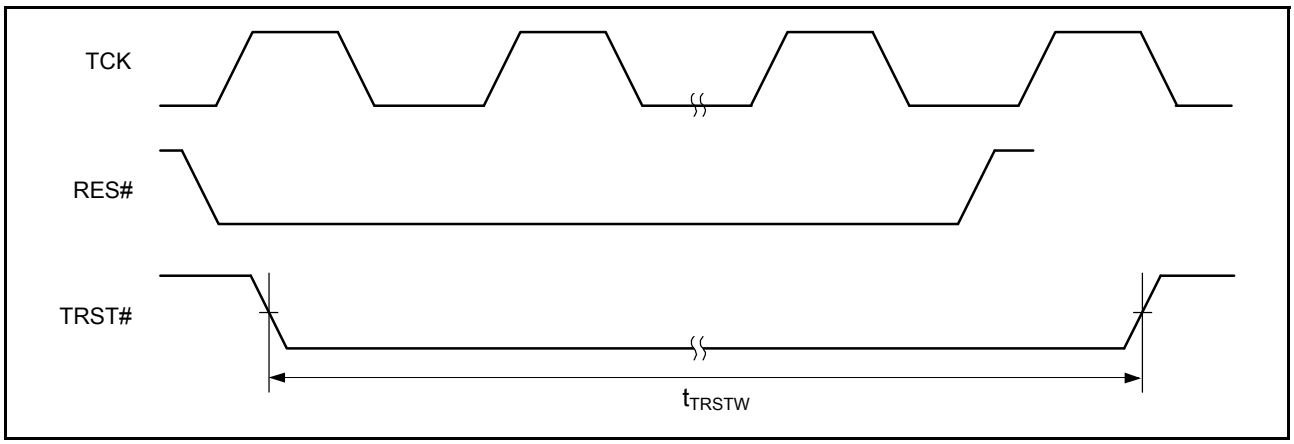


Figure 5.59 Boundary Scan TRST# Timing

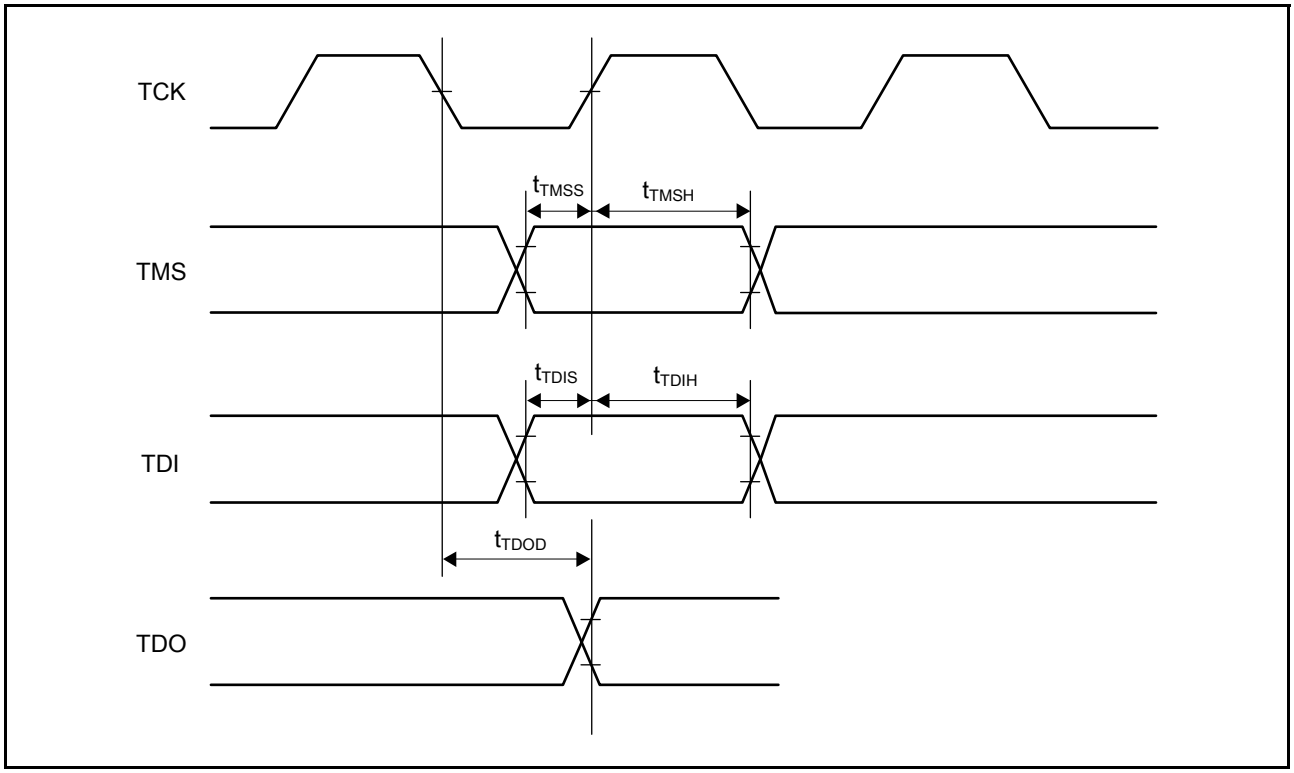


Figure 5.60 Boundary Scan Input/Output Timing

5.9 ROM (Flash Memory for Code Storage) Characteristics

Table 5.25 ROM (Flash Memory for Code Storage) Characteristics (1)

Conditions: VCC = PLLVCC = AVCC = VCC_USB = 2.7 to 3.6 V, VREFH = 2.7 V to AVCC
VSS = PLLVSS = AVSS = VREFL = VSS_USB = 0 V
Temperature range for the programming/erasure operation: T_a = -40 to +85°C

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Rewrite/erase cycle*1	N_{PEC}	1000	—	—	Times	
Data hold time	t_{DRP}	30*2	—	—	Year	T_a = +85°C

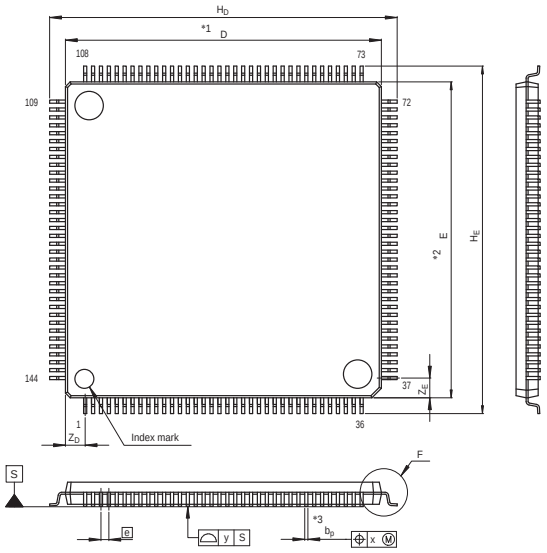
Note 1. Definition of reprogram/erase cycle:
The reprogram/erase cycle is the number of erasing for each block. When the reprogram/erase cycle is n times (n = 1000), erasing can be performed n times for each block. For instance, when 256-byte programming is performed 16 times for different addresses in 4-Kbyte block and then the entire block is erased, the reprogram/erase cycle is counted as one. However, programming the same address for several times as one erasing is not enabled (overwriting is prohibited).
Note 2. The result obtained from the reliability test.

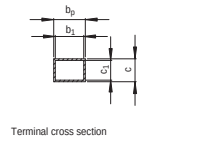
Table 5.26 ROM (Flash Memory for Code Storage) Characteristics (2)

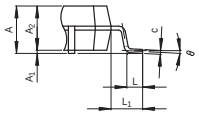
Conditions: VCC = PLLVCC = AVCC = VCC_USB = 2.7 to 3.6 V, VREFH = 2.7 V to AVCC
VSS = PLLVSS = AVSS = VREFL = VSS_USB = 0 V
Temperature range for the programming/erasure operation: T_a = -40 to +85°C

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Programming time	256 bytes	t_{P256}	—	2	12	ms	PCLK = 50 MHz $N_{PEC} \leq 100$
	4 Kbytes	t_{P4K}	—	23	50	ms	
	16 Kbytes	t_{P16K}	—	90	200	ms	
	256 byte	t_{P256}	—	2.4	14.4	ms	PCLK = 50 MHz $N_{PEC} > 100$
	4 Kbytes	t_{P4K}	—	27.6	60	ms	
	16 Kbytes	t_{P16K}	—	108	240	ms	
Erasure time	4 Kbytes	t_{E4K}	—	25	60	ms	PCLK = 50 MHz $N_{PEC} \leq 100$
	16 Kbytes	t_{E16K}	—	100	240	ms	
	4 Kbytes	t_{E4K}	—	30	72	ms	PCLK = 50 MHz $N_{PEC} > 100$
	16 Kbytes	t_{E16K}	—	120	288	ms	
Suspend delay time during writing		t_{SPD}	—	—	120	µs	Figure 5.67 PCLK = 50-MHz operation
First suspend delay time during erasing (in suspend priority mode)		t_{SESD1}	—	—	120	µs	
Second suspend delay time during erasing (in suspend priority mode)		t_{SESD2}	—	—	1.7	ms	
Suspend delay time during erasing (in erasure priority mode)		t_{SEED}	—	—	1.7	ms	

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LFQFP144-20x20-0.50	PLQP0144KA-A	144P6Q-A / FP-144L / FP-144LV	1.2g





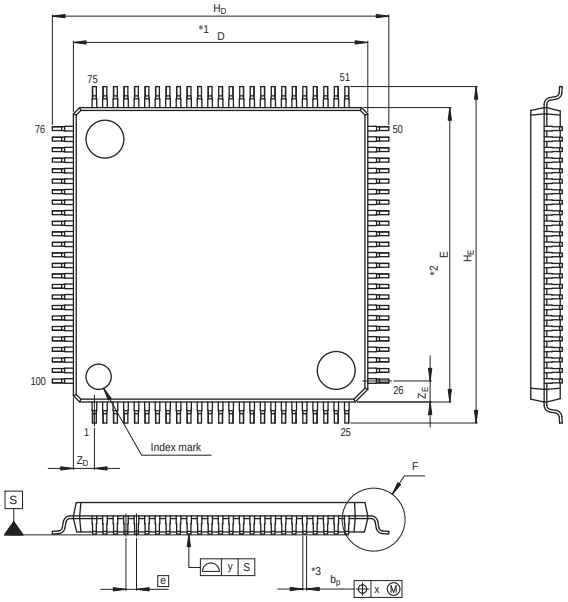


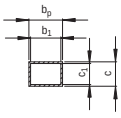
NOTE)
1. DIMENSIONS "*1" AND "*2" DO NOT INCLUDE MOLD FLASH.
2. DIMENSION "*3" DOES NOT INCLUDE TRIM OFFSET.

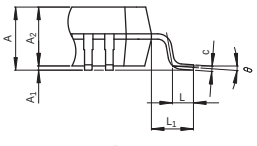
Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	19.9	20.0	20.1
E	19.9	20.0	20.1
A_2	—	1.4	—
H_D	21.8	22.0	22.2
H_E	21.8	22.0	22.2
A	—	—	1.7
A_1	0.05	0.1	0.15
b_p	0.17	0.22	0.27
b_1	—	0.20	—
c	0.09	0.145	0.20
c_1	—	0.125	—
θ	0°	—	8°
e	—	0.5	—
x	—	—	0.08
y	—	—	0.10
Z_D	—	1.25	—
Z_E	—	1.25	—
L	0.35	0.5	0.65
L_1	—	1.0	—

Figure C 144-Pin LQFP (PLQP0144KA-A) Package Dimensions

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LFQFP100-14x14-0.50	PLQP0100KB-A	100P6Q-A / FP-100U / FP-100UV	0.6g







NOTE)
1. DIMENSIONS "*1" AND "*2" DO NOT INCLUDE MOLD FLASH.
2. DIMENSION "*3" DOES NOT INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	13.9	14.0	14.1
E	13.9	14.0	14.1
A_2	—	1.4	—
H_D	15.8	16.0	16.2
H_E	15.8	16.0	16.2
A	—	—	1.7
A_1	0.05	0.1	0.15
b_p	0.15	0.20	0.25
b_1	—	0.18	—
c	0.09	0.145	0.20
c_1	—	0.125	—
θ	0°	—	8°
e	—	0.5	—
x	—	—	0.08
y	—	—	0.08
Z_D	—	1.0	—
Z_E	—	1.0	—
L	0.35	0.5	0.65
L_1	—	1.0	—

Figure D 100-Pin LQFP (PLQP0100KB-A) Package Dimensions

REVISION HISTORY — RX62N Group, RX621 Group Datasheet

Rev.	Date	Description	
		Page	Summary
1.00	2011.02.04	—	First Edition issued
1.10	2011.02.10	—	Features reviewed
1.20	2011.06.10		1. Overview
		2 to 5	Table 1.1 Outline of Specification, Description changed
		40 to 46	Table 1.9 Pin Functions, Description changed
			4. I/O Registers
		52 to 86	Table 4.1 List of I/O Registers (Address Order), Description changed
			5. Electrical Characteristics
		90	Table 5.2 DC Characteristics (3) , changed
		111	Figure 5.23 EDACK0 and EDACK1 Single-Address Transfer Timing (for a CS Area), changed
		111	Figure 5.24 EDACK0 and EDACK1 Single-Address Transfer Timing (for SDRAM), changed
1.30	2012.01.11		1. Overview
		2	Table 1.1 Outline of Specifications (1/4), changed, note 1, note 2 deleted
		13	Figure 1.6 Pin Assignment of the 144-Pin LQFP (Assistance Diagram), changed
		15	Figure 1.8 Pin Assignment of the 100-Pin LQFP (Assistance Diagram), changed
		33	Table 1.7 List of Pins and Pin Functions (100-Pin LQFP) (1/4), changed
		37	Table 1.8 List of Pins and Pin Functions (85-Pin TFLGA) (2/3), changed
			4. I/O Registers
		52 to 87	Table 4.1 List of I/O Registers (Address Order), Description changed
			5. Electrical Characteristics
		91	Table 5.4 DC Characteristics (3), specification added
		98	Table 5.9 Control Signal Timing, note changed
		122	Table 5.18 Timing of On-Chip Peripheral Modules (6), conditions changed